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Application ID: 10665651 *10665651*

Title of Invention: THIN AND HEAT RADIANT
SEMICONDUCTOR PACKAGE AND
METHOD FOR MANUFACTURING

First Named Inventor: Jae Ku

Domestic/Foreign Application: Domestic Application

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TRANSMITTAL

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Title of Invention	THIN AND HEAT RADIANT SEMICONDUCTOR PACKAGE AND METHOD FOR MANUFACTURING						
Application Number: 10/665651 *10/665651*							
Date: 2003-09-19							
First Named Applicant: Jae Hun Ku							
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Mark B. Garred Registered Number: 34,823	/mbg/	Attorney					

Documents being submitted us-ids	Files ids-usidst.xml us-ids.dtd us-ids.xsl
Comments	

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Electronic Version v18

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	9	4301464	1981-11-17	OTSUKI ET AL.
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Note: Applicant is not required to submit a paper copy of cited US Published Applications

init	Cite.No.	Pub. No.	Date	Applicant	Kind	Class	Subclass
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	10	20030073265	2003-04-17	HU ET AL.			

Signature

Examiner Name	Date